

ANNEX 3 TO TEST REPORT # EMCC-180541BGC, 2019-08-30**INTERNAL PHOTOGRAPHS OF EQUIPMENT UNDER TEST****EQUIPMENT UNDER TEST:**

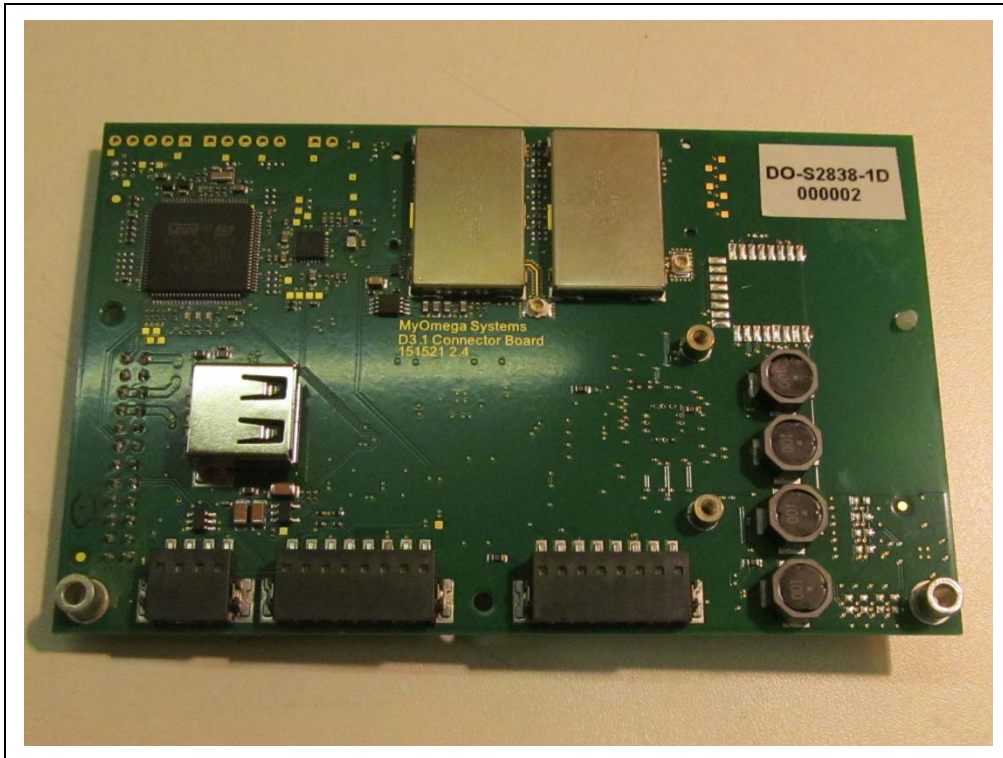
Trade Name:	Edge FCR 3
Type/Model:	110012
Serial Number(s):	00001101
Application:	Edge Computing Device
FCC ID:	2ASE6EDGEFCR3
Manufacturer:	MYNXG Product GmbH
Address:	Friedhofstraße 72 63263 Neu-Isenburg GERMANY
Phone:	+49 911 990 876 22
E-Mail:	christian.winkelmeyr@mynxg.com

RELEVANT STANDARD(S) : KDB 996369 D04 Module Integration Guide v01
47 CFR § 15.209

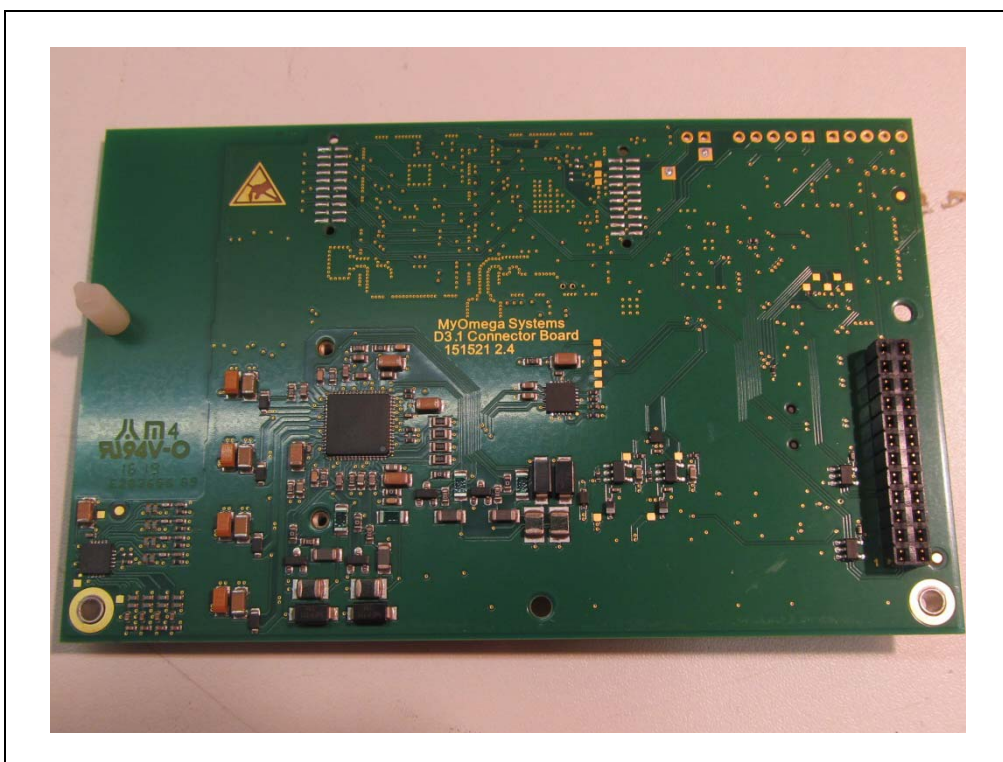
MEASUREMENT PROCEDURE: : ANSI C63.10-2013

ILLUSTRATION LIST ANNEX 3

Photograph A3-1: D3.1 Connector Board Top	2
Photograph A3-2: D3.1 Connector Board Bottom	2
Photograph A3-3: CPU Board Top	3
Photograph A3-4: CPU Board Bottom (with heatsink)	3
Photograph A3-5: D3 Carrier Board Top	4
Photograph A3-6: D3 Carrier Board Bottom with adhesive shielding material	4
Photograph A3-7: Photo of production sample of D3 Carrier Board Bottom.	5
Photograph A3-8: Connections of antennas	5
Photograph A3-9: Label of D3.1 Connector Board	6
Photograph A3-10: Label of D3.1 Connector Board	6
Photograph A3-11: Label of D3 Carrier Board	7
Photograph A3-12: Label of Label of D3 Carrier Board	7
Photograph A3-13: Label of WIFI module (on D3 Carrier Board)	8
Photograph A3-14: Label of Cellular radio module (on D3 Carrier Board)	8
Photograph A3-15: Label of CPU Board	9
Photograph A3-16: Label of CPU Board	9

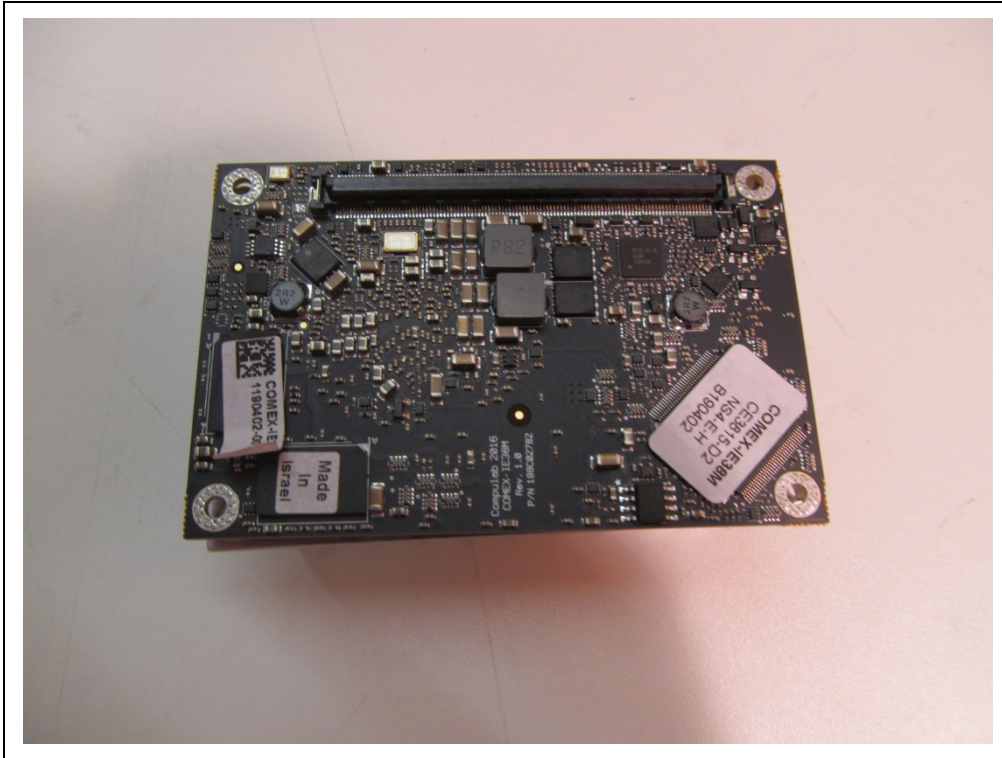


Photograph A3-1: D3.1 Connector Board Top

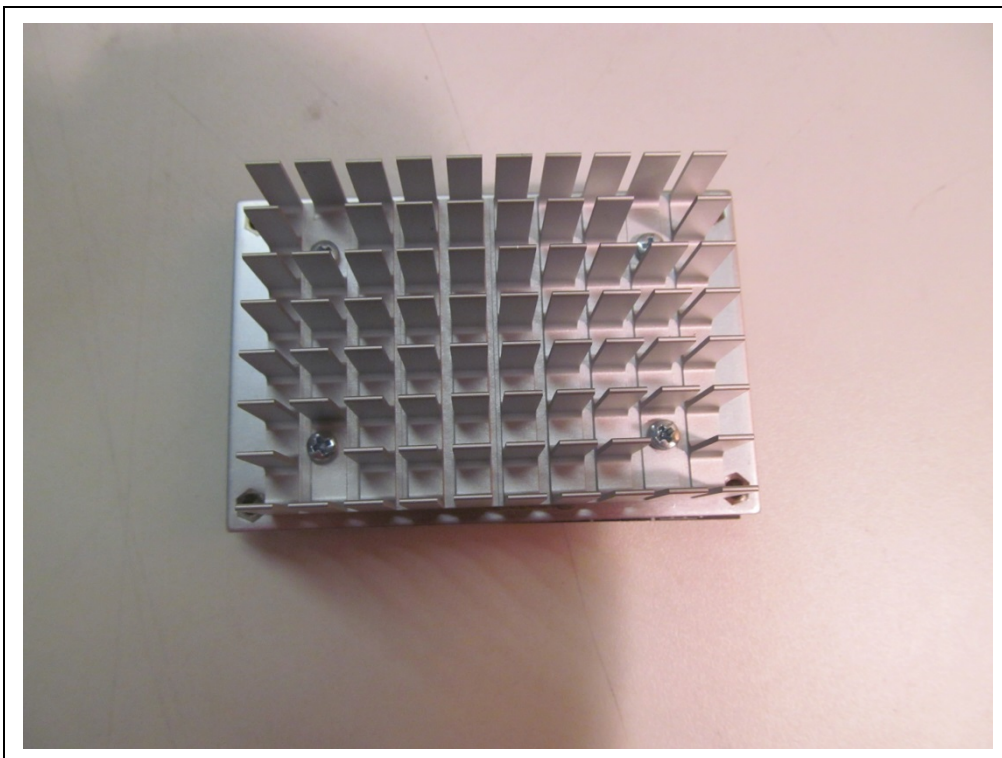


Photograph A3-2: D3.1 Connector Board Bottom

Test on MYNXG Product GmbH Edge FCR 3 to KDB 996369 D04 Module Integration Guide v01

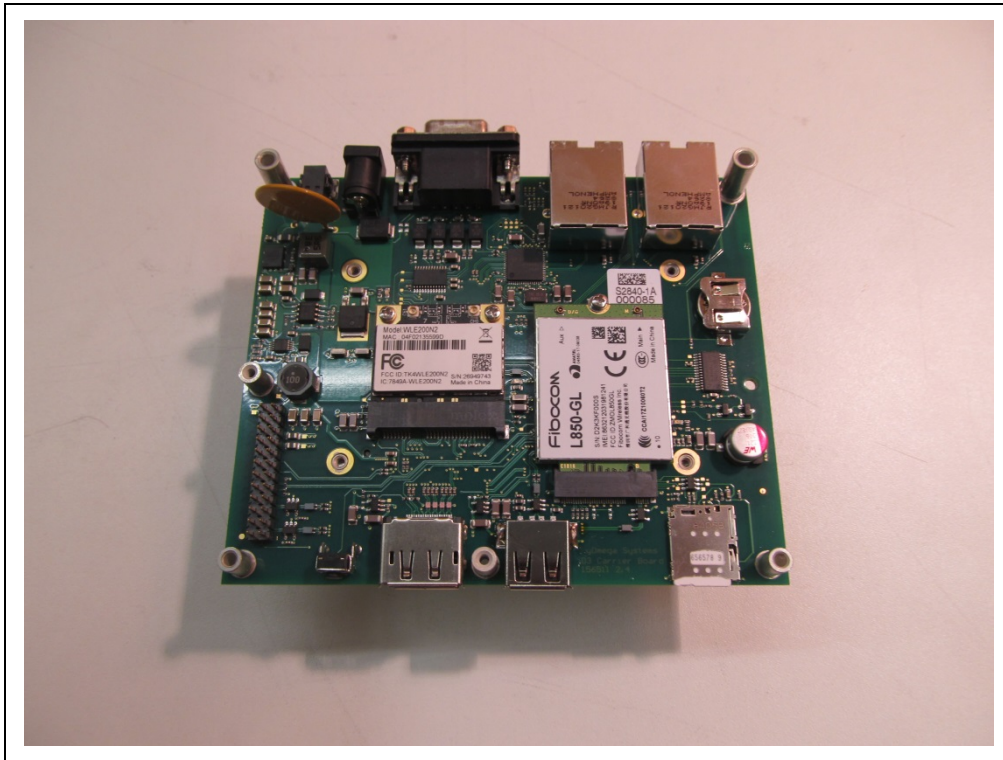


Photograph A3-3: CPU Board Top

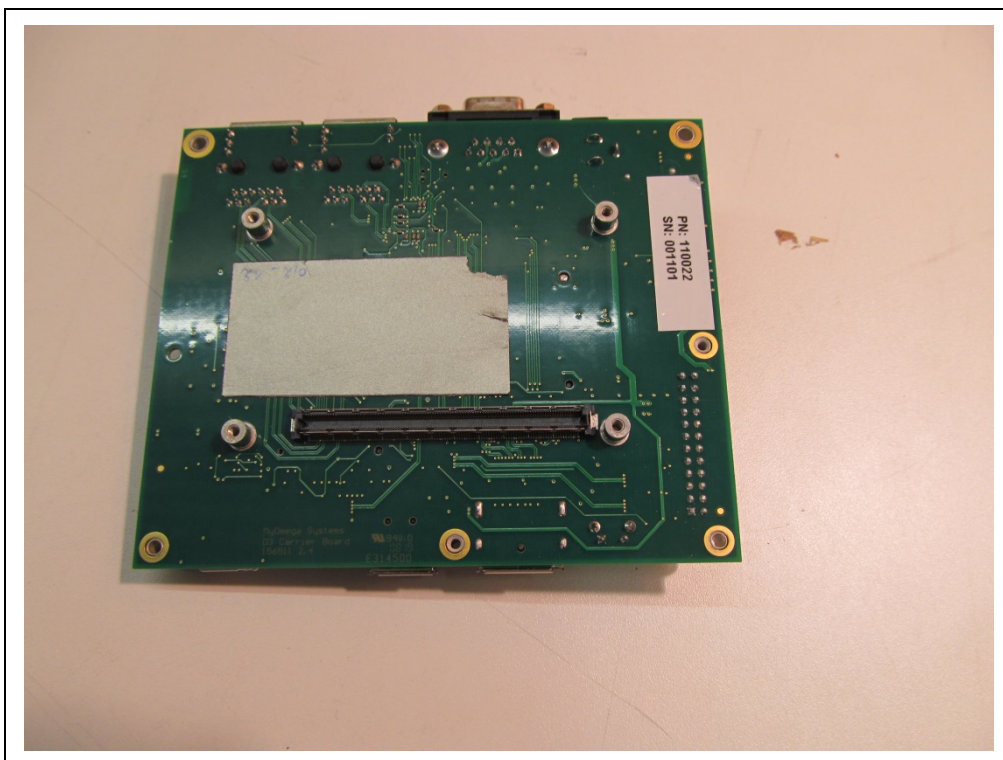


Photograph A3-4: CPU Board Bottom (with heatsink)

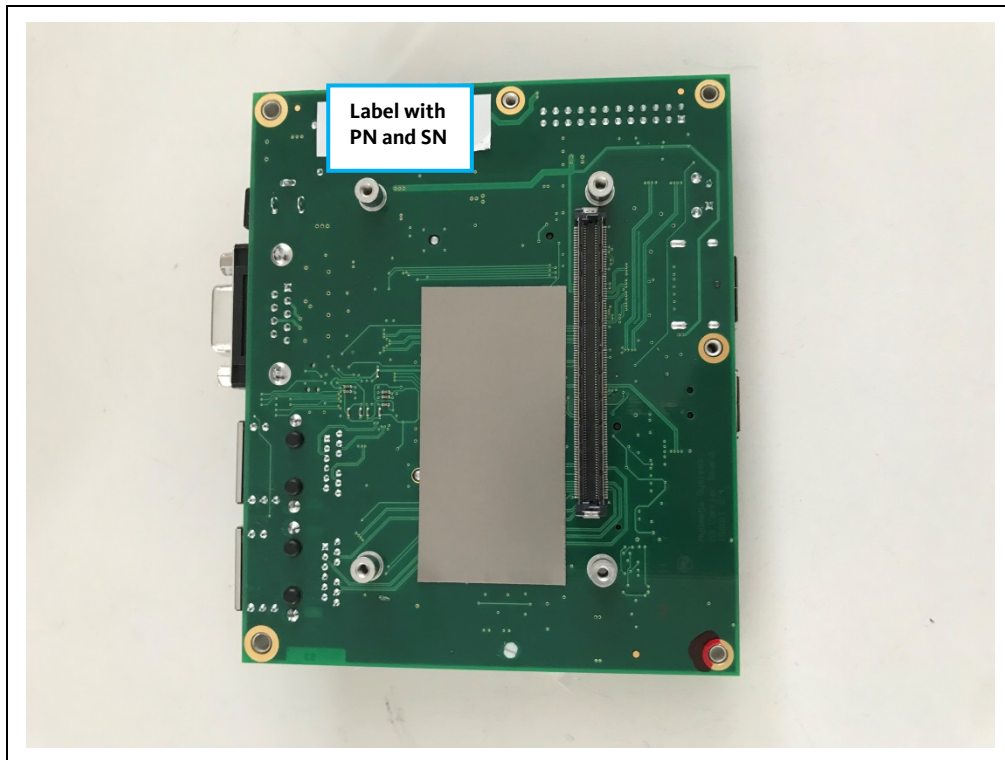
Test on MYNXG Product GmbH Edge FCR 3 to KDB 996369 D04 Module Integration Guide v01



Photograph A3-5: D3 Carrier Board Top

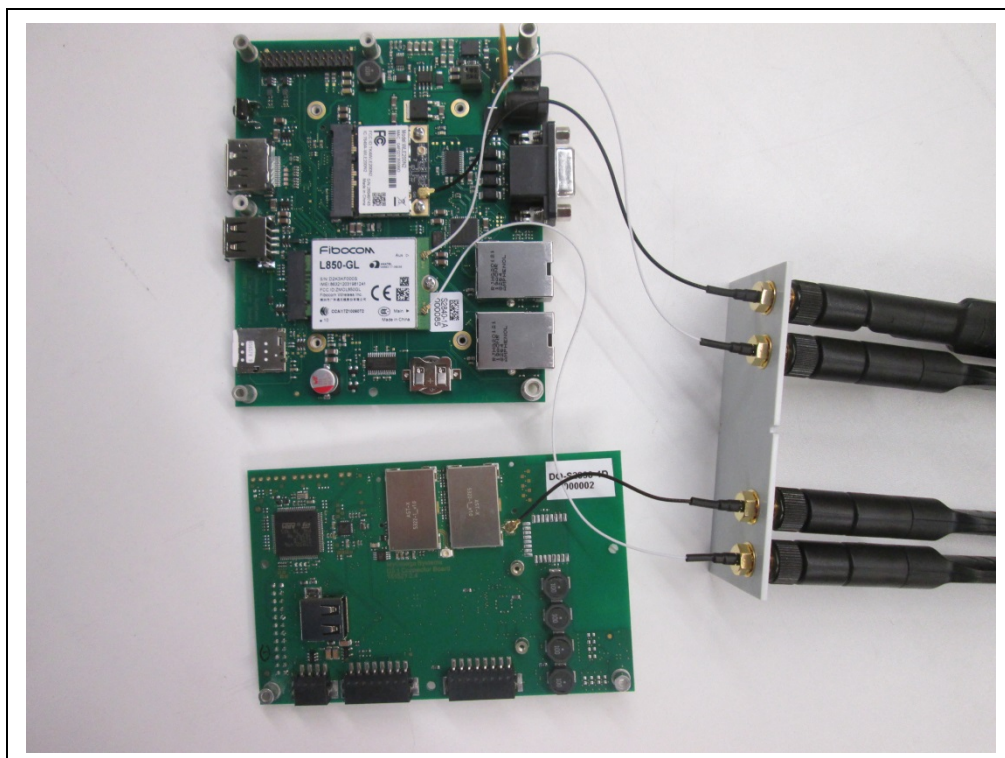


Photograph A3-6: D3 Carrier Board Bottom with adhesive shielding material

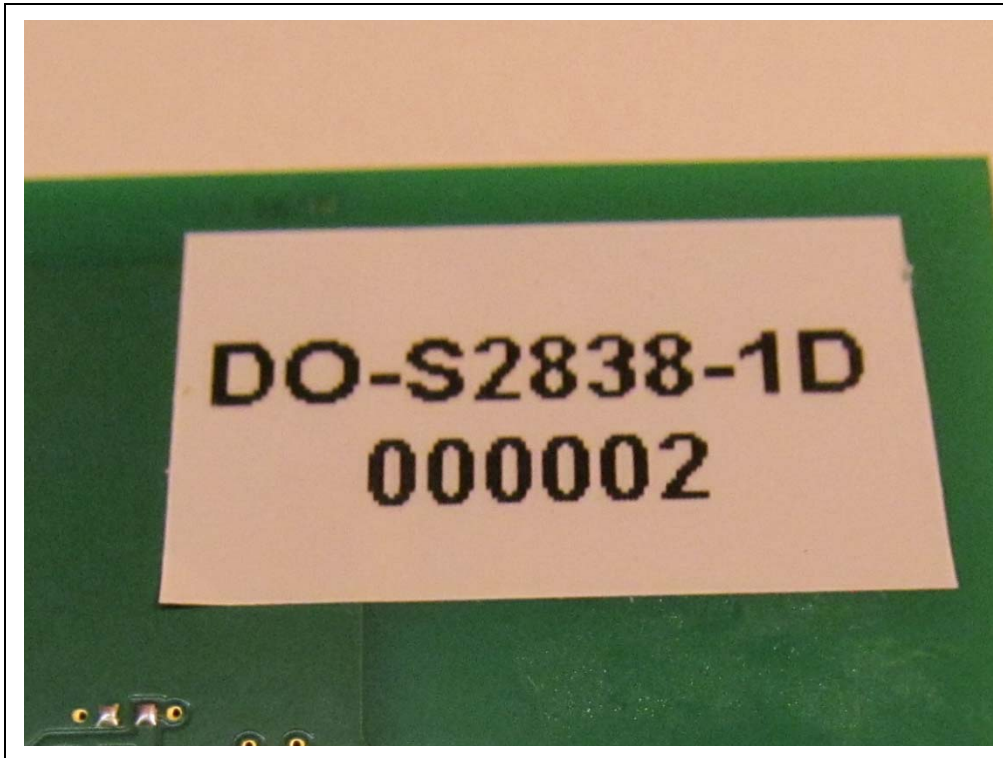


Photograph A3-7: Photo of production sample of D3 Carrier Board Bottom.

For information, only. Picture was delivered by customer. EUT was not used for testing.



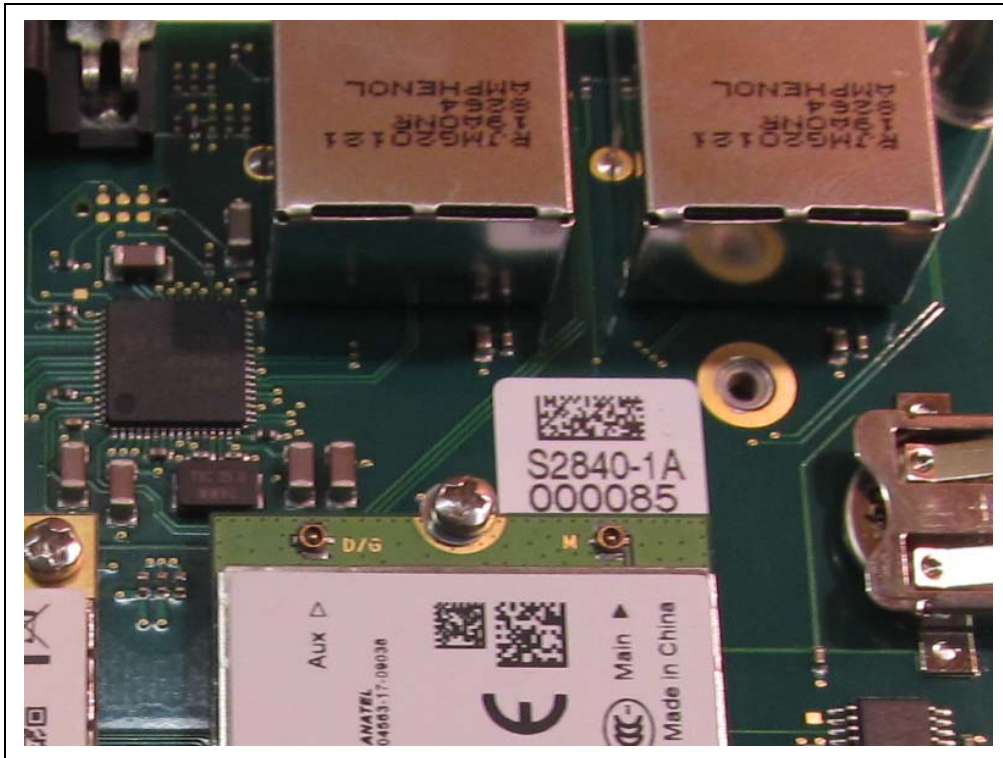
Photograph A3-8: Connections of antennas



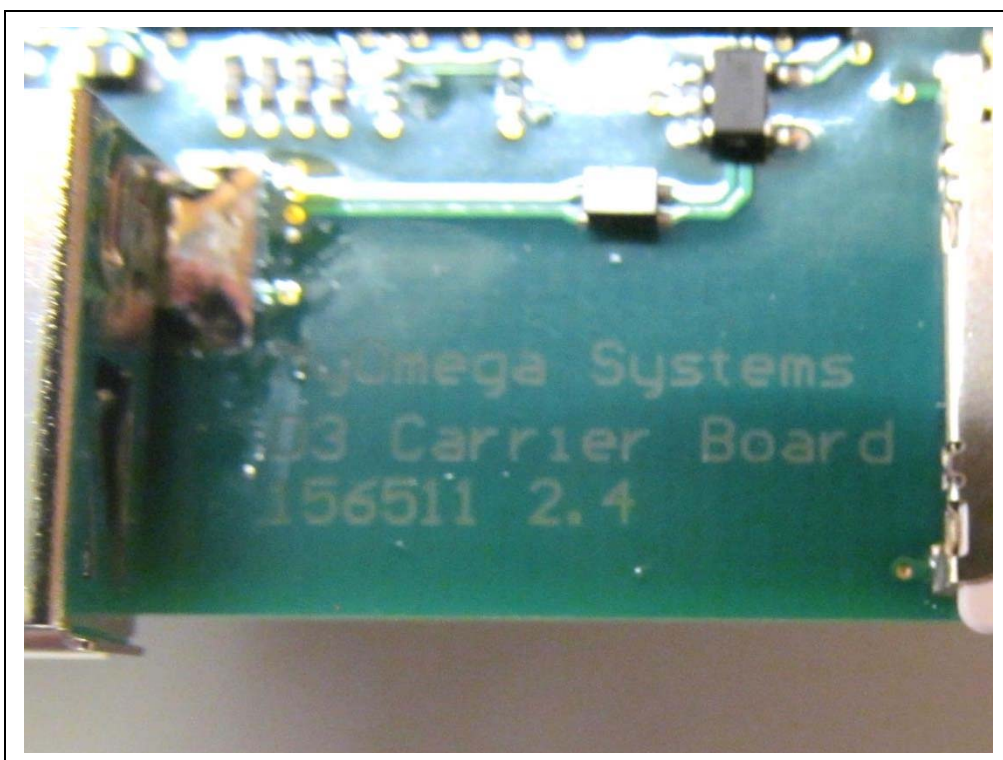
Photograph A3-9: Label of D3.1 Connector Board



Photograph A3-10: Label of D3.1 Connector Board



Photograph A3-11: Label of D3 Carrier Board



Photograph A3-12: Label of Label of D3 Carrier Board



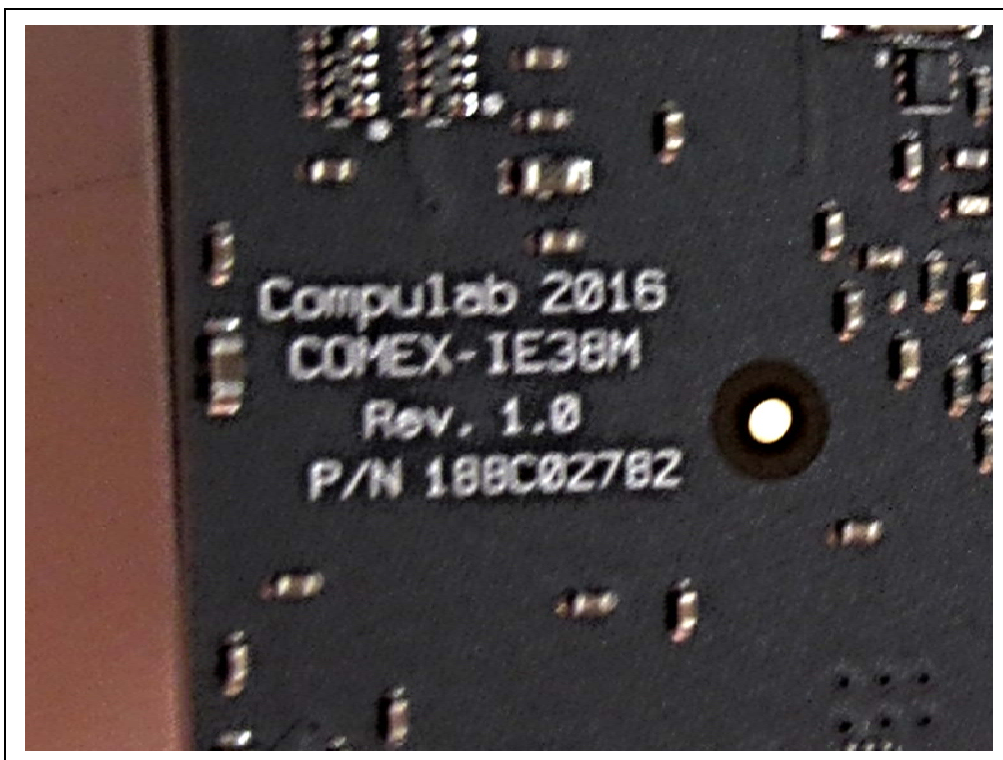
Photograph A3-13: Label of WIFI module (on D3 Carrier Board)



Photograph A3-14: Label of Cellular radio module (on D3 Carrier Board)



Photograph A3-15: Label of CPU Board



Photograph A3-16: Label of CPU Board